

**SUPPLEMENTAL DECLARATION**  
(Original Application)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed, as amended by any and all amendments entered during the prosecution of the patent application identified herein, and for which a patent is sought on the invention entitled **ALLOY TYPE THERMAL FUSE AND MATERIAL FOR A THERMAL FUSE ELEMENT** the specification of which was filed on **September 4, 2003** as Application No. **10/656,561**.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any and all amendments entered during the prosecution of the application.

I acknowledge the duty to disclose information which is material to patentability in accordance with Title 37, Code of Federal Regulations, Section 1.56.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of first or  
sole inventor

**Yoshiaki TANAKA**

Inventor's Signature

*Yoshiaki Tanaka*

Date

**January 29, 2007**

Residence

c/o Uchihashi Estec Co., Ltd. of 11-28, Shimanouchi 1-chome  
Chuo-ku, Osaka-shi, Osaka, Japan

Citizenship

**Japanese**

Post Office Address

c/o Uchihashi Estec Co., Ltd. of 11-28, Shimanouchi 1-chome  
Chuo-ku, Osaka-shi, Osaka, Japan